



Docket: 0756-1838

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

27/PRE.
Amtd. S
Shunsh
4-16-01

In re Patent Application of)
Shunpei YAMAZAKI et al.)
Serial No. 09/118,010) Art Unit: 2822
Filed: July 17, 1998) Examiner: M. Guerrero
For: SEMICONDUCTOR DEVICE,)
METHOD OF FABRICATING)
THE SAME, AND)
ELECTROOPTICAL DEVICE) Date: April 11, 2001

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PRELIMINARY AMENDMENT

Honorable Commissioner for Patents
Washington, D.C. 20231

Sir:

Please preliminarily amend the subject application as follows:

IN THE CLAIMS:

Please amend claims 1, 5, 11, 12, 18, 23, 28, and 33 as follows: Please note that these claims are presented below in their amended form. They are further presented as an Attachment to the Amendment whereby the amendments to the claims are outlined using the conventional method of bracketing and underlining.

1. (Twice Amended) A semiconductor device comprising:

a first resinous substrate having an uneven surface, a second resinous substrate opposed to said first resinous substrate, and a liquid crystal layer therebetween;

D' Sub 1